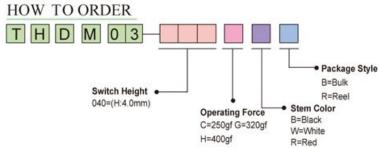
# **D SERIES**





# 6.0x6.0 Bracket Shape Type Tact Switch





#### **Features**

- Improve mounting density of components on PC board.
- Reflow solderable.
- Contacts are completely sealed, enhancing reliability.
- Packaged with a 12mm wide embossed taping.

### **Applications**

- For operating various mobile devices.
- For operating various devices that require high density mounting such as mobile phones, communication devices, compact electronic devices.

#### Specification

Items Operating temperature range		Standard	
			Electrical performance
Insulation resistance	100MWmin. 100V DC		
Dielectric strength	250V AC for 1 min.		
Contact resistance	100mWmax.		
Durability	Lifetime	C:50,000 Cycles G:H:30,000 Cycles	
Mechanical performance	Operating force	C:250gf G:320gf H:400gf	
	Travel	0.30 ± 0.1mm	

## Diagram

No.	Dimensions	Circuit Diagram Pad Layout
• THDM03	5.1 6.0 4.6 8.0 7.8	1.70 2.80 1.30 2.80 1.30 2.80 2.80 2.80 2.80 2.80 2.80 2.80 2.8

